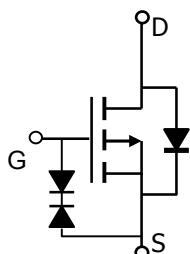
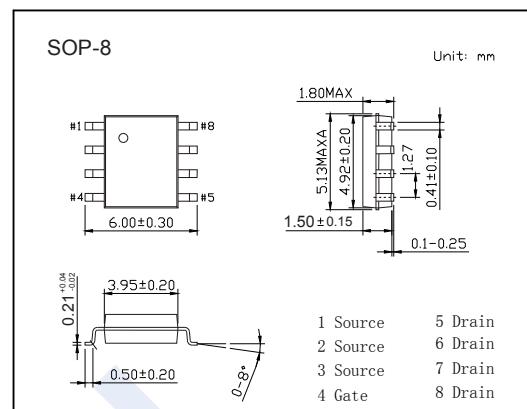


## P-Channel MOSFET

### AO4425 (KO4425)

#### ■ Features

- $V_{DS}$  (V) = -38V
- $I_D$  = -14 A ( $V_{GS}$  = -20V)
- $R_{DS(ON)}$  < 10m  $\Omega$  ( $V_{GS}$  = -20V)
- $R_{DS(ON)}$  < 11m  $\Omega$  ( $V_{GS}$  = -10V)
- ESD Rating: 3000V HBM



#### ■ Absolute Maximum Ratings $T_a = 25^\circ\text{C}$

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	-38	V
Gate-Source Voltage	$V_{GS}$	$\pm 25$	
Continuous Drain Current	$I_D$	-14	A
		-11	
Pulsed Drain Current	$I_{DM}$	-50	
Power Dissipation	$P_D$	3.1	W
		2	
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	40	$^\circ\text{C}/\text{W}$
		75	
Thermal Resistance.Junction- to-Lead	$R_{thJL}$	24	
Junction Temperature	$T_J$	150	$^\circ\text{C}$
Junction Storage Temperature Range	$T_{stg}$	-55 to 150	

## P-Channel MOSFET

### AO4425 (KO4425)

#### ■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =-250 μ A, V <sub>GS</sub> =0V	-38			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>D</sub> =-30V, V <sub>GS</sub> =0V			-100	nA
		V <sub>D</sub> =-30V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			-500	
Gate-Body leakage current	I <sub>GSS</sub>	V <sub>D</sub> =0V, V <sub>GS</sub> =±20V			±1	uA
		V <sub>D</sub> =0V, V <sub>GS</sub> =±25V			±10	
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>D</sub> =V <sub>GS</sub> , I <sub>D</sub> =-250 μ A	-2		-3.5	V
Static Drain-Source On-Resistance	R <sub>D(on)</sub>	V <sub>GS</sub> =-20V, I <sub>D</sub> =-14A			10	mΩ
		V <sub>GS</sub> =-20V, I <sub>D</sub> =-14A T <sub>J</sub> =125°C			13.5	
		V <sub>GS</sub> =-10V, I <sub>D</sub> =-14A			11	
On state drain current	I <sub>D(on)</sub>	V <sub>GS</sub> =-10V, V <sub>D</sub> =-5V	-50			A
Forward Transconductance	g <sub>FS</sub>	V <sub>D</sub> =-5V, I <sub>D</sub> =-14A		43		S
Input Capacitance	C <sub>iss</sub>	V <sub>GS</sub> =0V, V <sub>D</sub> =-20V, f=1MHz		3800		pF
Output Capacitance	C <sub>oss</sub>			560		
Reverse Transfer Capacitance	C <sub>rss</sub>			350		
Gate resistance	R <sub>g</sub>	V <sub>GS</sub> =0V, V <sub>D</sub> =0V, f=1MHz		7.5		Ω
Total Gate Charge	Q <sub>g</sub>	V <sub>GS</sub> =-10V, V <sub>D</sub> =-20V, I <sub>D</sub> =-14A		63		nC
Gate Source Charge	Q <sub>gs</sub>			14.1		
Gate Drain Charge	Q <sub>gd</sub>			16.1		
Turn-On DelayTime	t <sub>d(on)</sub>	V <sub>GS</sub> =-10V, V <sub>D</sub> =-20V, R <sub>L</sub> =1.35Ω, R <sub>GEN</sub> =3Ω		12.4		ns
Turn-On Rise Time	t <sub>r</sub>			9.2		
Turn-Off DelayTime	t <sub>d(off)</sub>			97.5		
Turn-Off Fall Time	t <sub>f</sub>			45.5		
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> =-14A, dI/dt=100A/us		35		nC
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>			33		
Maximum Body-Diode Continuous Current	I <sub>s</sub>				-4.2	A
Diode Forward Voltage	V <sub>SD</sub>	I <sub>s</sub> =-1A, V <sub>GS</sub> =0V			-1	V

Note : The static characteristics in Figures 1 to 6 are obtained using <300μs pulses, duty cycle 0.5% max.

#### ■ Marking

Marking	4425 KC****
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## P-Channel MOSFET

### AO4425 (KO4425)

#### ■ Typical Characteristics

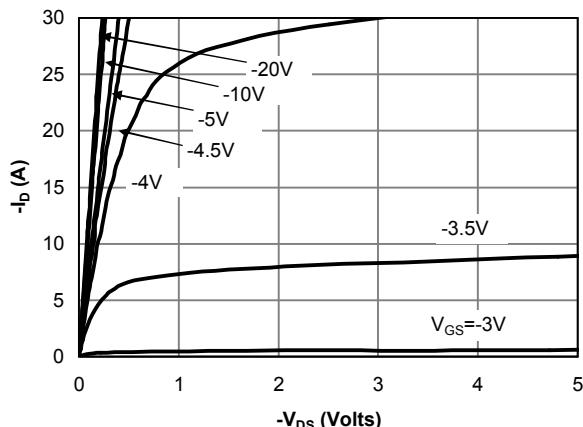


Fig 1: On-Region Characteristics

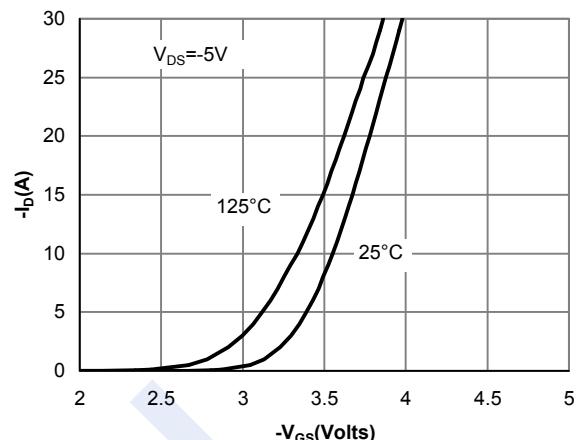


Figure 2: Transfer Characteristics

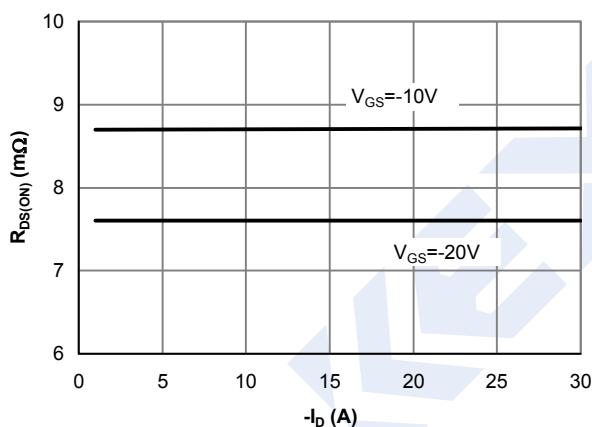


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

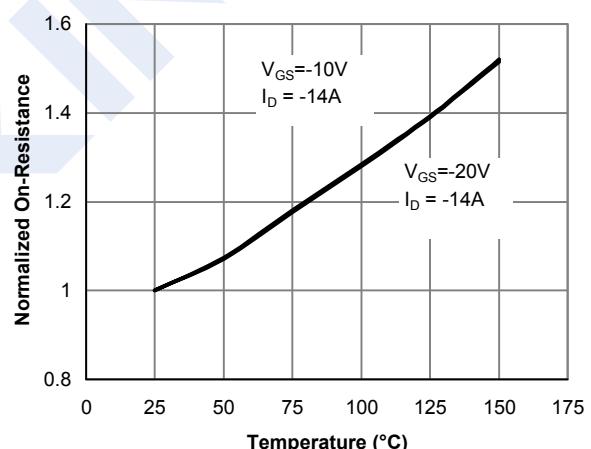


Figure 4: On-Resistance vs. Junction Temperature

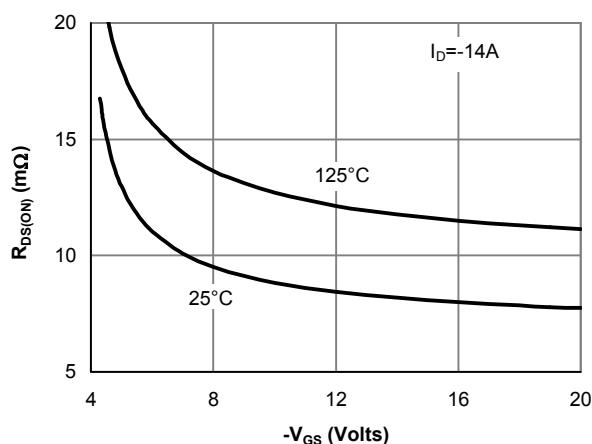


Figure 5: On-Resistance vs. Gate-Source Voltage

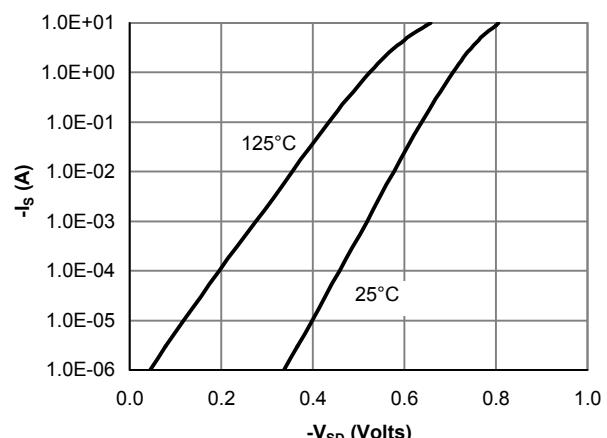


Figure 6: Body-Diode Characteristics

## P-Channel MOSFET

### AO4425 (KO4425)

#### ■ Typical Characteristics

